

TSM6025

A +2.5V, Low-Power/Low-Dropout Precision Voltage Reference

FEATURES

- Alternate Source for MAX6025
- Initial Accuracy:
 0.2% (max) TSM6025A
 0.4% (max) TSM6025B
- 0.4% (max) TSM6025B
 Temperature Coefficient: 15ppm/°C (max) – TSM6025A
- 25ppm/°C (max) TSM6025B
- Quiescent Supply Current: 35µA (max)
 Low Supply Current Change with V_{IN}: <1µA/V
- Low Supply Current Change with V_{IN}: <1µ*A* Output Source/Sink Current: ±500µA
- Output Source/Sink Current: ±500µA
 Law Drawout at 500µA Load Output 100
- Low Dropout at 500µA Load Current: 100mV
- Load Regulation: 0.14μV/μA
- Line Regulation : 25µV/V
- Stable with CLOAD up to 2200pF

APPLICATIONS

Industrial and Process-Control Systems Hard-Disk Drives Battery-Operated Equipment Data Acquisition Systems Hand-Held Equipment Precision 3V/5V Systems Smart Industrial Transmitters

DESCRIPTION

The TSM6025 is a 3-terminal, series-mode 2.5-V precision voltage reference and is a pin-for-pin, alternate source for the MAX6025 voltage reference. Like the MAX6025, the TSM6025 consumes only 27µA of supply current at no-load, exhibits an initial output voltage accuracy of less than 0.2%, and a low output voltage temperature coefficient of 15ppm/°C. In addition, the TSM6025's output stage is stable for all capacitive loads to 2200pF and is capable of sinking and sourcing load currents up to 500µA.

Since the TSM6025 is a series-mode voltage reference, its supply current is not affected by changes in the applied supply voltage unlike twoterminal shunt-mode references that require an external resistor. The TSM6025's small form factor and low supply current operation combine to make it an ideal choice in low-power, precision applications.

The TSM6025 is fully specified over the -40°C to +85°C temperature range and is available in a 3-pin SOT23 package.

TYPICAL APPLICATION CIRCUIT





ABSOLUTE MAXIMUM RATINGS

IN to GND	
OUT to GND	0.3V to 7V
Short Circuit to GND or IN (V _{IN} < 6V)	Continuous
Output Short Circuit to GND or IN $(V_{IN} \ge 6V)$.	60s
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
3-Pin SOT23 (Derate at 4.0mW/°C above	e +70°C)320mW

Operating Temperature Range	40°C to +85°C
Storage Temperature Range	
Lead Temperature (Soldering, 10s)	+300°C

Electrical and thermal stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to any absolute maximum rating conditions for extended periods may affect device reliability and lifetime.

PACKAGE/ORDERING INFORMATION



Lead-free Program: Silicon Labs supplies only lead-free packaging.

Consult Silicon Labs for products specified with wider operating temperature ranges.



ELECTRICAL CHARACTERISTICS

 $V_{IN} = +5V$, $I_{OUT} = 0$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$. See Note 1.

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
OUTPUT							
Output Voltage	V _{OUT}	$T_{A} = +25^{\circ}C \qquad \qquad \frac{TSM6025A}{TSM6025B}$	TSM6025A	2.495	2.500	2.505	V
				-0.20		0.20	%
			2.490	2.500	2.510	V	
			1 510100250	-0.40		0.40	%
Output Voltage Temperature Coefficient (See Note 2)	V _{OUT}	$T_A = 0^{\circ}C$ to $+70^{\circ}C$	TSM6025A		6	15	ppm/°C
		$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$			6	20	
		$T_A = 0^{\circ}C$ to $+70^{\circ}C$	TSM6025B		6	25	
		$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$			6	30	
Line Regulation	ΔV _{OUT} / ΔV _{IN}	$(V_{OUT}+0.2V) \leq V_{IN} \leq 12.6V$				140	μV/V
Lood Regulation	ΔV_{OUT}	Sourcing: $0 \le I_{OUT} \le 500\mu A$ Sinking: -500 $\mu A \le I_{OUT} \le 0$			0.14	0.60	μV/μA
Load Regulation	Δl _{out}				0.18	0.80	
Dropout Voltage (See Note 5)	V_{IN} - V_{OUT}	$I_{OUT} = 500 \mu A$			100	200	mV
OLIT Short Circuit Current		VOUT Short to GND	4		4		m۸
OUT Short-Circuit Current	ISC	V _{OUT} Short to IN			4		IIIA
Temperature Hysteresis (See Note 3)					130		ppm
Long-Term Stability	ΔV _{OUT} / time	1000hr at $T_A = +25^{\circ}C$			50		ppm/ 1000hr
DYNAMIC							
Noise Voltage	e _{out}	f = 0.1Hz to $10Hz$			50		μV_{P-P}
		f = 10Hz to 10kHz			125		μV_{RMS}
Ripple Rejection	ΔV _{OUT} / ΔV _{IN}	$V_{IN} = 5V \pm 100 \text{mV}, \text{ f} = 120 \text{H}.$	z		82		dB
Capacitive-Load Stability Range	COUT	See Note 4		0		2.2	nF
INPUT							
Supply Voltage Range	VIN	Guaranteed by line-regulati	on test	V _{OUT} + 0.2		12.6	V
Quiescent Supply Current	I _{IN}				27	35	μA
Change in Supply Current	I_{IN}/V_{IN}	$(V_{OUT} + 0.2V) \le V_{IN} \le 12.6V$				2.0	μA/V

Note 1: All devices are 100% production tested at $T_A = +25^{\circ}$ C and are guaranteed by characterization for $T_A = T_{MIN}$ to T_{MAX} , as specified. **Note 2:** Temperature Coefficient is measured by the "box" method; i.e., the maximum ΔV_{OUT} is divided by the maximum ΔT . **Note 3:** Temperature hysteresis is defined as the change in the $+25^{\circ}$ C output voltage before and after cycling the device from T_{MIN} to T_{MAX} . Note 4: Not production tested; guaranteed by design.

Note 5: Dropout voltage is the minimum input voltage at which V_{OUT} changes ≤0.2% from V_{OUT} at V_{IN} = 5.0V.



TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} = +5V; I_{OUT} = 0mA; T_{A} = +25°C, unless otherwise noted.





Dropout Voltage vs Source Current



Power Supply Rejection vs Frequency





TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} = +5V; I_{OUT} = 0mA; T_{A} = +25°C, unless otherwise noted.





Power-On Transient Response



200µs/DIV



0.1Hz to 10Hz Output Noise









10µs/DIV



TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} = +5V; I_{OUT} = 0mA; T_{A} = +25°C, unless otherwise noted.



10µs/DIV



2µs/DIV



PIN FUNCTIONS

PIN	NAME	FUNCTION
1	IN	Supply Voltage Input
2	OUT	+2.5V Output
3	GND	Ground

DESCRIPTION/THEORY OF OPERATION

The TSM6025 incorporates a precision 1.25-V bandgap reference that is followed by a output amplifier configured to amplify the base bandgap output voltage to a 2.5-V output. The design of the bandgap reference incorporates proprietary circuit design techniques to achieve its low temperature coefficient of 15ppm/°C and initial output voltage accuracy less than 0.2%. The design of the output

amplifier's frequency compensation does not require a separate compensation capacitor and is stable with capacitive loads up to 2200pF. The design of the output amplifier also incorporates low headroom design as it can source and sink load currents to 500μ A with a dropout voltage less than 200mV.

APPLICATIONS INFORMATION

Power Supply Input Capacitive Bypass

As shown in the Typical Application Circuit, the V_{IN} pin of the TSM6025 should be bypassed to GND with a 0.1 µF ceramic capacitor for optimal line-transient performance. Consistent with good analog circuit engineering practice, the capacitor should be placed in as close proximity to the TSM6025 as practical with very short pcb track lengths.

Output/Load Capacitance Considerations

As mentioned previously, the TSM6025 does not require a separate, external capacitor at V_{OUT} for transient response stability as it is stable for capacitive loads up to 2200pF. On the other hand and for improved large-signal line and load regulation, the use of a capacitor at V_{OUT} will provide a reservoir of charge in reserve to absorb large-signal load or line transients. This in turn improves the TSM6025's V_{OUT} settling time. If large load and line transients are not expected in the application, then the TSM6025 can be used without an external capacitor at V_{OUT} thereby reducing the overall circuit footprint.

Supply Current

The TSM6025 exhibits excellent dc line regulation as its supply current changes slightly as the applied supply voltage is increased. While its supply current is 35µA maximum, the change in its supply current as a function of supply voltage (its $\Delta I_{IN}/\Delta V_{IN}$) is less

than 1μ A/V. Since the TSM6025 is a series-mode reference, load current is drawn from the supply voltage only when required. In this case, circuit efficiency is maintained at all applied supply voltages. Reducing power dissipation and extending battery life are the net benefits of improved circuit efficiency.

On the other hand, an external resistor in series with the supply voltage is required by two-terminal, shunt-mode references. In this case, as the supply voltage changes, so does the quiescent supply current of the shunt reference. In addition, the external resistor's tolerance and temperature coefficient contribute two additional factors that can affect the circuit's supply current. Therefore, maximizing circuit efficiency with shunt-mode references becomes an exercise involving three variables. Additionally, shunt-mode references must be biased at the maximum expected load current even if the load current is not present at all times.

When the applied supply voltage is less than the minimum specified input voltage of the TSM6025 (for example, during the power-up transition), the TSM6025 can draw up to 200µA above its nominal, steady-state supply current. To ensure reliable power-up behavior, the input power source must have sufficient reserve power to provide the extra supply current drawn during the power-up transition.



Output Voltage Hysteresis

Reference output voltage thermal hysteresis is the change in the reference's +25°C output voltage after temperature cycling from +85°C to +25°C and from -40°C to +25°C. Thermal hysteresis is caused by differential package stress impressed upon the TSM6025's internal bandgap core transistors and depends on whether the reference IC was previously at a higher or lower temperature. At 130ppm, the TSM6025's typical temperature hysteresis is equal to 0.33mV with respect to a 2.5V output voltage.

Voltage Reference Turn-On Time

With a $(V_{IN} - V_{OUT})$ voltage differential larger than 200mV and $I_{LOAD} = 0$ mA, the TSM6025's typical

combined turn-on and settling time to within 0.1% of its 2.5V final value is approximately $340\mu s$.

A Positive and Negative Low-Power Voltage Reference

The circuit in Figure 1 uses a CD4049 hex inverter and a few external capacitors as the power supply to a dual-supply precision op amp to form a $\pm 2.5V$ precision, bipolar output voltage reference around the TSM6025. The CD4049-based circuit is a discrete charge pump voltage doubler/inverter that generates $\pm 6V$ supplies for any industry-standard OP-07 or equivalent precision op amp.



Figure 1: Positive and Negative 2.5V References from a Single +3V or +5V Supply



PACKAGE OUTLINE DRAWING

3-Pin SOT23 Package Outline Drawing

(N.B., Drawings are not to scale)



NOTE:

- Does not include mode flash, protrusions or gate burns. Mode flash, protrusions or gate burns shall not exceed 0.127 mm per side
- \wedge Does not include inter-lead flash or protrusions.
- $\frac{1}{2}$ Inter-lead flash and protrusions shall not exceed 0.127 mm per side.
- 3. Die is facing up for mold die and trim-form.
- 4. Lead span/stand of high/coplanarity are considered as special characteristic.
- 5. All specifications referd JEDEC TO-236AB except for lead length dimension.
- 6 Controlling dimension in (mm)

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